Micropower, 150 mA Low-Noise, High PSRR, Ultra-Low Dropout BiCMOS Voltage Regulator

The NCP3985 is 150 mA LDO that provides the engineer with a very stable, accurate voltage with low noise and high Power Supply Rejection Ratio (PSRR) suitable for sensitive applications. In order to optimize performance for battery operated portable applications, the NCP3985 employs an advanced BiCMOS process to combine the benefits of low noise and superior dynamic performance of bipolar elements with very low ground current consumption at full loads offered by CMOS.

The NCP3985 is stable with small, low value capacitors and is available in TSOP-5 package.

Features

- Output Voltage Options:
 - 1.8 V, 2.5 V, 2.75 V, 2.8 V, 3.0 V, 3.3 V
 - Contact Factory for Other Voltage Options
- Output Current Limit 200 mA
- Low Noise (typ 20 μV_{rms})
- High PSRR (typ 70 dB)
- Stable with Ceramic Output Capacitors as low as 1 µF
- Low Sleep Mode Current (max 1 µA)
- Active Discharge Circuit
- Current Limit Protection
- Thermal Shutdown Protection
- Direct Replacement for LP3985
- These are Pb-Free Devices

Typical Applications

- Cellular Telephones
- Noise Sensitive Applications (Video, Audio)
- Analog Power Supplies
- PDAs / Palmtops / Organizers / GPS
- Battery Supplied Devices

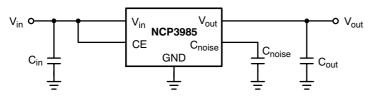
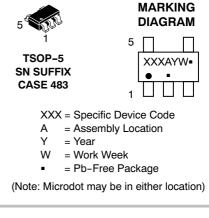


Figure 1. Typical Application Schematic

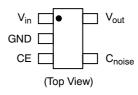


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ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 9 of this data sheet.

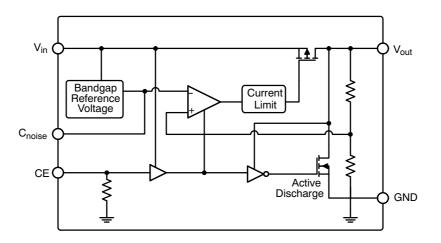


Figure 2. Simplified Block Diagram

PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	V _{in}	Power Supply Input Voltage
2	GND	Power Supply Ground
3	CE	Chip Enable: This pin allows on/off control of the regulator. To disable the device, connect to GND. If this function is not in use, connect to V_{in} . Internal 5 M Ω Pull Down resistor is connected between CE and GND.
4	C _{noise}	Noise reduction pin. (Connect 100 nF or 10 nF capacitor to GND)
5	V _{out}	Regulated Output Voltage

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V _{in}	-0.3 V to 6 V	V
Chip Enable Voltage	V _{CE}	–0.3 V to V _{in} +0.3 V	V
Noise Reduction Voltage	V _{Cnoise}	–0.3 V to V _{in} +0.3 V	V
Output Voltage	V _{out}	–0.3 V to V _{in} +0.3 V	V
Maximum Junction Temperature (Note 1)	T _{J(max)}	150	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: This device series contains ESD protection and exceeds the following tests: Human Body Model 2000 V per MIL-STD-883, Method 3015

Machine Model Method 200 V per MIL-STD-883, M

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Package Thermal Resistance: (Note 1) Junction-to-Lead (pin 5) Junction-to-Ambient	$R_{ extsf{ heta}JA}$	109 220	°C/W

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area

ELECTRICAL CHARACTERISTICS

 $(V_{in} = V_{out} + 0.5 \text{ V}, V_{CE} = 1.2 \text{ V}, C_{in} = 0.1 \text{ }\mu\text{F}, C_{out} = 1 \text{ }\mu\text{F}, C_{noise} = 10 \text{ }n\text{F}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}, \text{ unless otherwise specified (Note 2)})$

Characteristic	Test Conditions	Symbol	Min	Тур	Max	Unit
REGULATOR OUTPUT						
Input Voltage		V _{in}	2.5	-	5.5	V
Output Voltage (Note 3) 1.8	V V _{in} = (V _{out} + 0.5 V) to 5.5 V	Vout	1.764	-	1.836	V
2.5	V I _{out} = 1 mA		2.450	-	2.550	
2.75	V		2.695	-	2.805	
2.8			2.744	-	2.856	
3.0			2.940	-	3.060	
3.3	V		3.234 (-2%)	-	3.366 (+2%)	
Output Voltage (Note 3) 1.8	V V _{in} = (V _{out} + 0.5 V) to 5.5 V	Vout	1.746	-	1.854	V
2.5	V I _{out} = 1 mA to 150 mA		2.425	-	2.575	
2.75	V		2.6675	-	2.8325	
2.8	V		2.716	-	2.884	
3.0			2.910	-	3.090	
3.3	V		3.201	-	3.399	
			(-3%)		(+3%)	
Power Supply Ripple Rejection	$V_{in} = V_{out} + 0.5 V + 0.5 V_{p-p}$	PSRR				dB
	$I_{out} = 1 \text{ mA to } 150 \text{ mA}$ f = 120 Hz		-	70	-	
	C _{noise} = 100nF f = 1 kHz		-	70	-	
	f = 10 kHz		-	55	-	
Line Regulation	$V_{in} = (V_{out} + 0.5 \text{ V}) \text{ to } 5.5 \text{ V}, I_{out} = 1 \text{ mA}$	Reg _{line}	-0.2	-	0.2	%/V
Load Regulation	I _{out} = 1 mA to 150 mA	Reg _{load}	-	12	25	mV
Output Noise Voltage	f = 10 Hz to 100 kHz	Vn				μV _{rms}
	$I_{out} = 1 \text{ mA to } 150 \text{ mA} C_{noise} = 100 \text{ nF}$		-	20	-	
	C _{noise} = 10 nF		-	25	-	
Output Current Limit	$V_{out} = V_{out(nom)} - 0.1 V$	I _{LIM}	200	310	470	mA
Output Short Circuit Current	V _{out} = 0 V	I _{SC}	210	320	490	mA
Dropout Voltage (Note 4) 2.5	V I _{out} = 150 mA	V _{DO}	-	105	155	mV
2.75	V		-	105	155	
2.8	V		-	105	155	
3.0	V		-	100	150	
3.3	V		-	100	150	
GENERAL						
Ground Current	l _{out} = 1 mA	I _{GND}	-	70	90	μΑ
	l _{out} = 150 mA		-	110	220	
Disable Current	V _{CE} = 0 V	I _{DIS}	-	0.1	1	μΑ
Thermal Shutdown Threshold (Note 5)		T _{SD}	-	150	-	°C
Thermal Shutdown Hysteresis (Note 5)		T _{SH}	-	20	-	°C
CHIP ENABLE						
Input Threshold Lo		V _{th(CE)}	-	-	0.4	V
Hi	·		1.2	-	-	
Internal Pull-Down Resistance (Note 6		R _{PD(CE)}	2.5	5	10	MΩ
TIMING						
Turn-on Time	$I_{out} = 150 \text{ mA}$ $C_{noise} = 10 \text{ nF}$ $C_{noise} = 100 \text{ nF}$	t _{on}	-	0.4 4	-	ms
Turn-off Time	$C_{noise} = 10 \text{ nF}/100 \text{ nF}$ $I_{out} = 1 \text{ mA}$	t _{off}	-	800	-	μs
		•off	_	000	_	μο

Performance guaranteed over the indicated operating temperature range by design and/or characterization, production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
Contact factory for other voltage options.

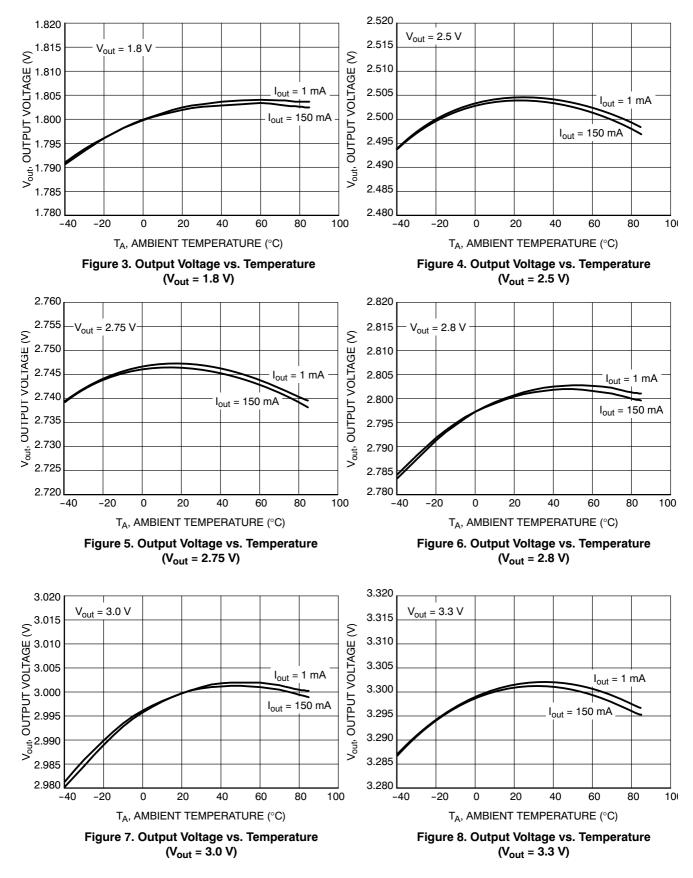
 $I_{out} = 10 \text{ mA}$

200

4. Measured when output voltage falls 100 mV below the regulated voltage at $V_{in} = V_{out} + 0.5 V$ if $V_{out} < 2.5 V$, then $V_{DO} = V_{in} - V_{out}$ at $V_{in} = 2.5 V$.

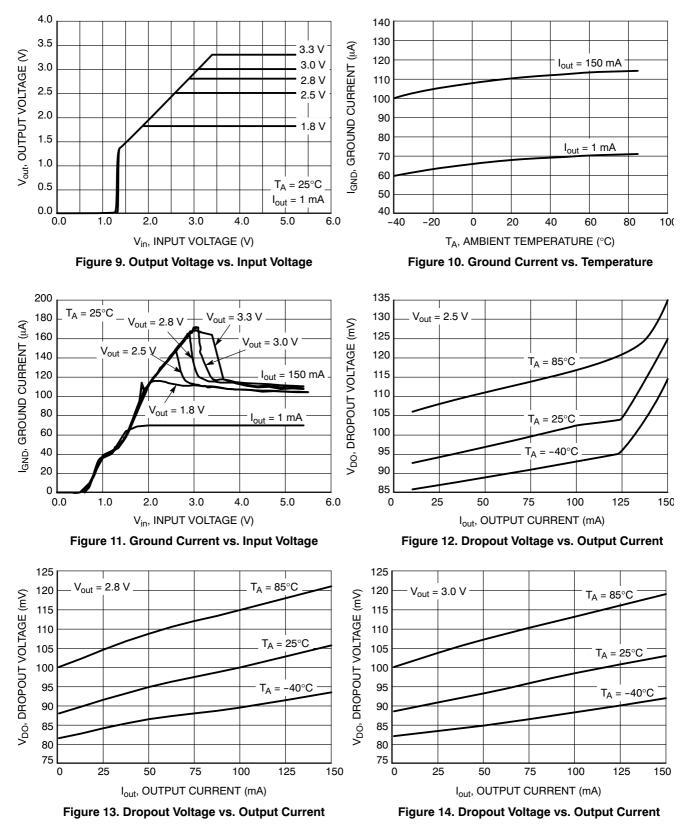
5. Guaranteed by design and characterization.

6. Expected to disable device when CE pin is floating.

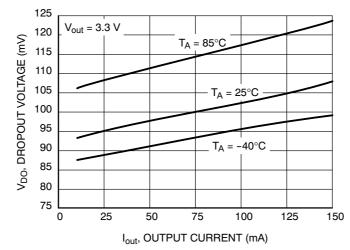


TYPICAL CHARACTERISTICS

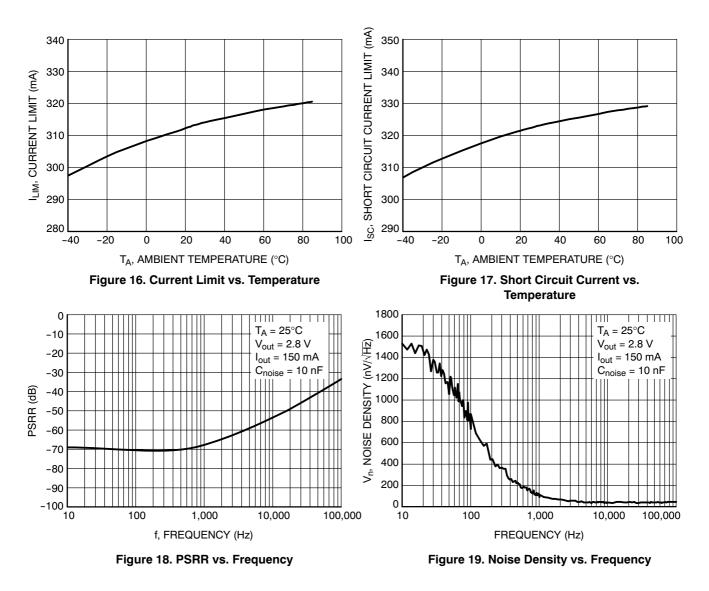
TYPICAL CHARACTERISTICS



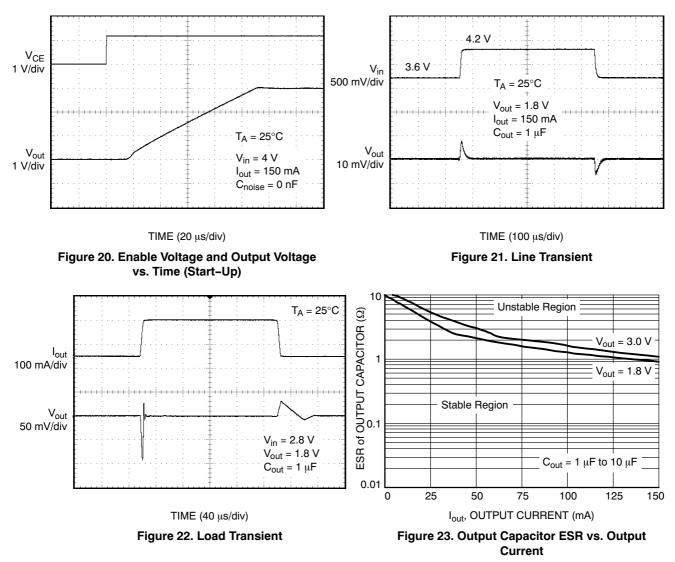
TYPICAL CHARACTERISTICS







TYPICAL CHARACTERISTICS



NOTE: Typical characteristics were measured with the same conditions as electrical characteristics, unless otherwise noted.

APPLICATION INFORMATION

General

The NCP3985 is a 200 mA (current limited) linear regulator with a logic input for on/off control for the high speed turn-off output voltage.

Access to the major contributor of noise within the integrated circuit is provided as the focus for noise reduction within the linear regulator system.

Power Up/Down

During power up, the NCP3985 maintains a high impedance output (V_{out}) until sufficient voltage is present on V_{in} to power the internal bandgap reference voltage. When sufficient voltage is supplied (approx 1.2 V), V_{out} will start to turn on (assume CE shorted to V_{in}), linearly increasing until the output regulation voltage has been reached.

Active discharge circuitry has been implemented to insure a fast turn off time. Then CE goes low, the active discharge transistor turns on creating a fast discharge of the output voltage. Power to drive this circuitry is drawn from the output node. This is to maintain the lowest quiescent current when in the sleep mode ($V_{CE} = 0.4$ V). This circuitry subsequently turns off when the output voltage discharges.

CE (chip enable)

The enable function is controller by the logic pin CE. The voltage threshold of this pin is set between 0.4 V and 1.2 V. A voltage lower than 0.4 V guarantees the device is off. A voltage higher than 1.2 V guarantees the device is on. The NCP3985 enters a sleep mode when in the off state drawing less than 1 μ A of quiescent current.

The device can be used as a simple regulator without use of the chip enable feature by tying the CE pin to the V_{in} pin.

Current Limit

Output Current is internally limited within the IC to a minimum of 200 mA. The design is set to a higher value to allow for variation in processing and the temperature coefficient of the parameter. The NCP3985 will source this amount of current measured with a voltage 100 mV lower than the typical operating output voltage.

The specification for short circuit current limit (@ $V_{out} = 0 V$) is specified at 320 mA (typ). There is no additional circuitry to lower the current limit at low output voltages. This number is provided for informational purposes only.

Output Capacitor

The NCP3985 has been designed to work with low ESR ceramic capacitors. There is no ESR lower limit for stability for the recommended 1 μ F output capacitor. Stable region for Output capacitor ESR vs Output Current is shown in Figure 23.

Typical characteristics were measured with Murata ceramic capacitors. GRM219R71E105K (1 μ F, 25 V, X7R, 0805) and GRM21BR71A106K (10 μ F, 10 V, X7R, 0805).

Output Noise

The main contributor for noise present on the output pin V_{out} is the reference voltage node. This is because any noise which is generated at this node will be subsequently amplified through the error amplifier and the PMOS pass device. Access to the reference voltage node is supplied directly through the C_{noise} pin. Noise can be reduced from a typical value of 25 μV_{rms} by using 10 nF to 20 μV_{rms} by using a 100 nF from the C_{noise} pin to ground.

A bypass capacitor is recommended for good noise performance and better load transient response.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold, a Thermal Shutdown (TSD) event is detected and the output (V_{out}) is turned off. There is no effect from the active discharge circuitry. The IC will remain in this state until the die temperature moves below the shutdown threshold (150°C typical) minus the hysteresis factor (20°C typical).

This feature provides protection from a catastrophic device failure due to accidental overheating. It is not intended to be used as a substitute for proper heat sinking. The maximum device power dissipation can be calculated by:

$$\mathsf{P}_{\mathsf{D}} = \frac{\mathsf{T}_{\mathsf{J}} - \mathsf{T}_{\mathsf{A}}}{\mathsf{R}_{\mathsf{\theta}\mathsf{J}\mathsf{A}}}$$

Thermal resistance value versus copper area and package is shown in Figure 24.

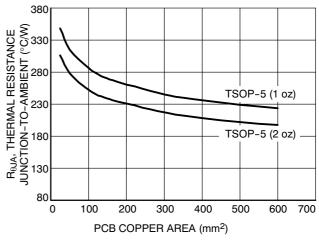


Figure 24. R_{0JA} vs. PCB Copper Area

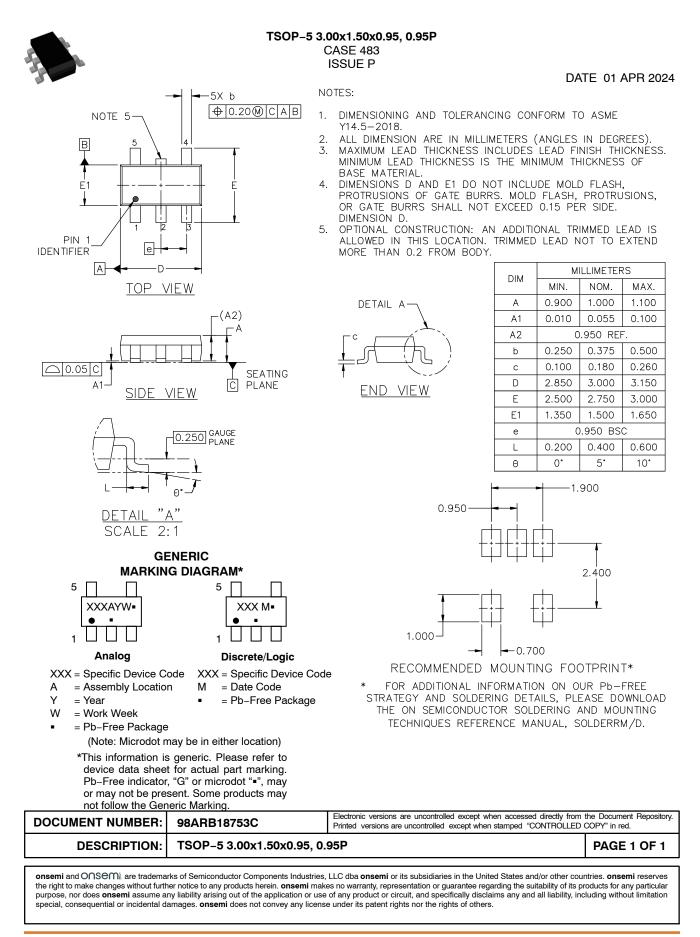
ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping†		
NCP3985SN18T1G	1.8 V	LKA				
NCP3985SN25T1G	2.5 V	LKD		2020 / Tana & Daal		
NCP3985SN275T1G	2.75 V	LKE	TSOP-5			
NCP3985SN28T1G	2.8 V	LKB	(Pb-Free)	3000 / Tape & Reel		
NCP3985SN30T1G	3.0 V	LKC				
NCP3985SN33T1G	3.3 V	LKF				

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

The products described herein (NCP3985), may be covered by one or more U.S. patents.

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